

01-31-2001



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B/O FORM PTO-1595 (Rev. 4/00)

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10-22-01

To the Commissioner for Patents. Please record the attached original documents or copies thereof.

1. Name of Conveying Party(ies):

Seiji YOSHIDA

2. Name and Address of Receiving Party(ies):

Name: JAPAN BLOWER IND. CO., LTD.

Internal Address:

Street Address: 27-10, Kasuga-nishimachi
2-chome

City, State, Zip: Hirakata-shi, Osaka JAPAN

☐ Additional names of conveying parties attached.

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

Execution Date: January 18, 2001

☐ Additional name(s) and address(es) attached.

4. (A) Patent Application Number(s):

Entitled: "A Bamboo Floor Plate For Sound Insulation"

4. (B) Patent Number(s):

09765612

If this document is being filed together with a new
application, the execution date of the application is: January 18,
2001☐ Additional Numbers Attached

5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:

Name: Eugene Mar

Address: Bacon & Thomas, PLLC
625 Slaters Lane Fourth Floor
Alexandria, VA 22314Total Number of Applications and
Patents Involved:

1

7. Total Fee:
(37 CFR 3.41)

\$40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit Account Number: 02-0200

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Eugene Mar

January 22, 2001

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and document: 2

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 PATENT
 REEL: 011465 FRAME: 0338

ASSIGNMENT

WHEREAS, I (we), **Seiji YOSHIDA**

whose post office address(es) appears below, hereinafter referred to as ASSIGNOR, is(are) the owner of certain new and useful improvements in

A Bamboo Floor Plate for Sound Insulation

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was

☒ executed on even date herewith

☐ executed on:

☐ filed on:

Serial No.:

☐ established by PCT International Patent Application No.:
designating the United States of America

filed:

WHEREAS, **JAPAN BLOWER IND. CO., LTD.**

whose post office address is **27-10, Kasuga-nishimachi 2-chome, Hirakata-shi, Osaka, JAPAN**

hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of *Bacon & Thomas* to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Assignor Name Seiji YOSHIDA	Address 43-3, Matsuzuka, Katano-shi, Osaka 576-0043, JAPAN
Where Signed Hirakata, Japan	
Date January 18, 2001	Signature <i>Seiji Yoshida</i>
Witness (optional)	Witness (optional)
Print/Type Name	Print/Type Name
Signature	Signature

☐ Continued on Next Page